## STD26P3LLH6



# P-channel 30 V, 0.024 Ω typ., 12 A, STripFET™ VI DeepGATE™ Power MOSFET in a DPAK package

Datasheet - production data

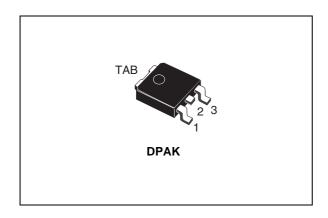
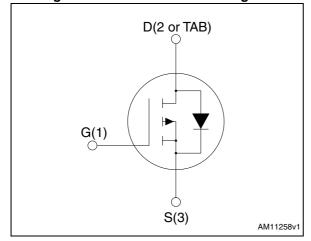


Figure 1. Internal schematic diagram



#### **Features**

Order code	V <sub>DSS</sub>	R <sub>DS(on)</sub> I <sub>D</sub> P		P <sub>TOT</sub>
STD26P3LLH6	30 V	$0.030~\Omega^{(1)}$	12 A	40 W

- 1. @ V<sub>GS</sub>= 10 V
- R<sub>DS(on)</sub> \* Q<sub>q</sub> industry benchmark
- Extremely low on-resistance R<sub>DS(on)</sub>
- High avalanche ruggedness
- · Low gate input resistance

#### **Applications**

- · Switching applications
- LCC converters, resonant converters

#### Description

This device is a P-channel Power MOSFET developed using the  $\boldsymbol{\theta}^{th}$  generation of STripFETTM DeepGATETM technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest  $R_{DS(on)}$  in all packages

Table 1. Device summary

Order code	Marking	Package	Packaging
STD26P3LLH6	26P3LLH6	DPAK	Tape and reel

Note: For the P-channel Power MOSFETs the actual polarity of the voltages and the current must be reversed.

Contents STD26P3LLH6

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STD26P3LLH6 Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-source voltage	30	V
V <sub>GS</sub>	Gate-source voltage	±20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	12	Α
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	8.5	Α
I <sub>DM</sub> (1)(2)	Drain current (pulsed)	48	Α
P <sub>TOT</sub> (1)	Total dissipation at T <sub>C</sub> = 25 °C	40	W
T <sub>stg</sub>	Storage temperature	-55 to 175	°C
Tj	Max. operating junction temperature	175	°C

<sup>1.</sup> Limited by wire bonding.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	3.75	°C/W

**Table 4. Avalanche characteristics** 

Syn	nbol	Parameter	Value	Unit
E	AS	Single pulse avalanche energy (starting $T_J$ =25 °C, $I_D$ =6 A, $I_{AS}$ =12 A, $V_{DD}$ =25 V, $V_{gs}$ =10 V)	350	mJ

Note:

For the P-channel Power MOSFETs the actual polarity of the voltages and the current must be reversed.

<sup>2.</sup> Pulse width limited by safe operating area.

Electrical characteristics STD26P3LLH6

## 2 Electrical characteristics

(T<sub>CASE</sub> = 25 °C unless otherwise specified)

Table 5. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown Voltage	$I_D = 250 \mu\text{A},  V_{GS} = 0$	30			٧
1	Zero gate voltage drain	V <sub>DS</sub> = 30 V			1	μΑ
I <sub>DSS</sub>	current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 30 V, Tc = 125 °C			10	μΑ
I <sub>GSS</sub>	Gate body leakage current	$V_{GS} = \pm 20 \text{ V}, (V_{DS} = 0)$			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		2.5	٧
R <sub>DS(on)</sub>	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, I_D = 6 \text{ A}$		0.024	0.03	Ω
		$V_{GS} = 4.5 \text{ V}, I_D = 6 \text{ A}$		0.038	0.045	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	1450	-	pF
C <sub>oss</sub>	Output capacitance	V <sub>DS</sub> = 25 V, f=1 MHz,	-	178	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0$	-	120	-	pF
Qg	Total gate charge	V <sub>DD</sub> = 24 V, I <sub>D</sub> = 12 A V <sub>GS</sub> = 4.5 V	-	12	-	nC
Q <sub>gs</sub>	Gate-source charge		-	4.4	-	nC
$Q_{gd}$	Gate-drain charge	(see Figure 14)	-	5	-	nC
R <sub>g</sub>	Gate input resistance	f = 1 MHz, gate DC Bias = 0, test signal level = 20 mV, I <sub>D</sub> = 0	-	1.8	-	Ω

Note: For the P-channel Power MOSFETs the actual polarity of the voltages and the current must be reversed.

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Table 7. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time		-	15	-	ns
t <sub>r</sub>	Rise time	$V_{DD} = 24 \text{ V}, I_{D} = 1.5 \text{ A},$ $R_{G} = 4.7 \Omega, V_{GS} = 10 \text{ V}$	-	15	-	ns
t <sub>d(off)</sub>	Turn-off delay time	$G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see Figure 13)	-	24	-	ns
t <sub>f</sub>	Fall time		-	21	-	ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		12	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		48	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage $I_{SD} = 12 \text{ A}, V_{GS}$		-		1.1	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 12 A,	-	15		ns
Q <sub>rr</sub>	Reverse recovery charge	di/dt = 100 A/μs, V <sub>DD</sub> = 16 V	-	6.5		nC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 15)	-	0.9		Α

<sup>1.</sup> Pulse width limited by safe operating area

Note:

For the P-channel Power MOSFETs the actual polarity of the voltages and the current must be reversed.

<sup>2.</sup> Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%

**Electrical characteristics** STD26P3LLH6

#### **Electrical characteristics (curves)** 2.1

Figure 2. Safe operating area

AM15963v1 Tj=175°C Tc=25°C Single puls (A) 100µs 10 1ms 10ms 0.1 10 V<sub>D</sub>s(V)

Figure 3. Thermal impedance

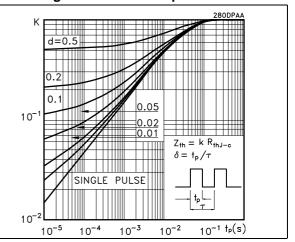


Figure 5. Transfer characteristics

Figure 4. Output characteristics

AM15964v1 ID(A) ID(A) V<sub>DS</sub>=1V 35 35

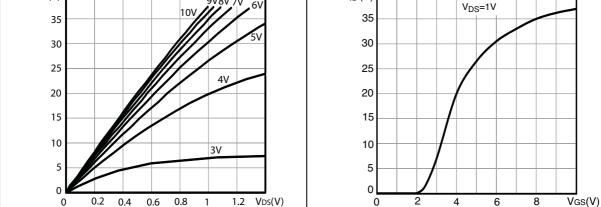
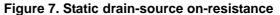
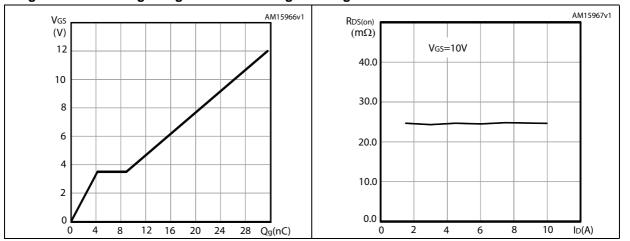


Figure 6. Gate charge vs gate-source voltage

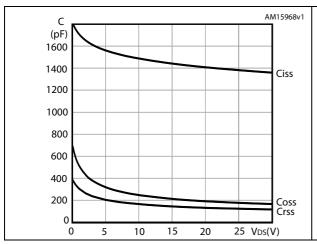




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Figure 8. Capacitance variations

Figure 9. Normalized gate threshold voltage vs temperature



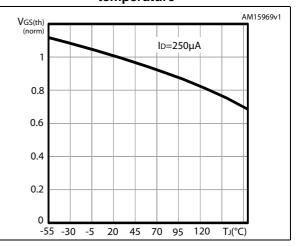
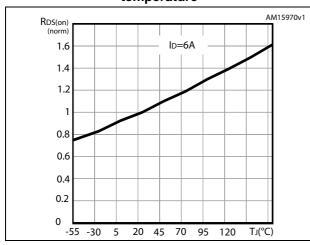


Figure 10. Normalized on-resistance vs temperature

Figure 11. Normalized  $\mathbf{V}_{\text{DS}}$  vs temperature



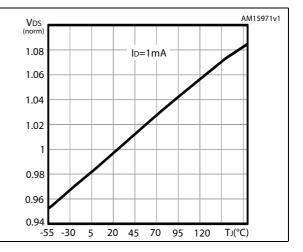
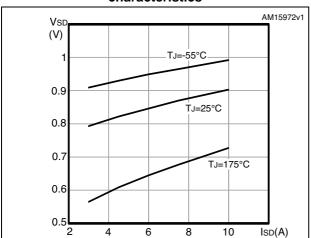


Figure 12. Source-drain diode forward characteristics



Test circuits STD26P3LLH6

## 3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

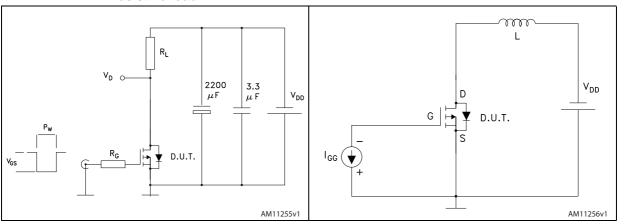


Figure 15. Test circuit for diode recovery behavior

Figure 16. Unclamped inductive load test circuit

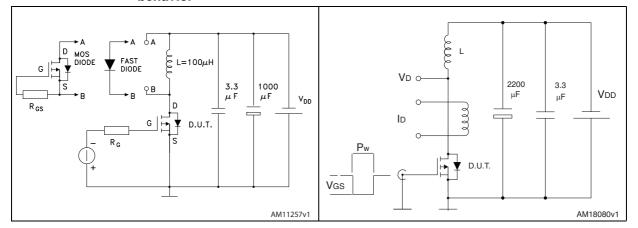
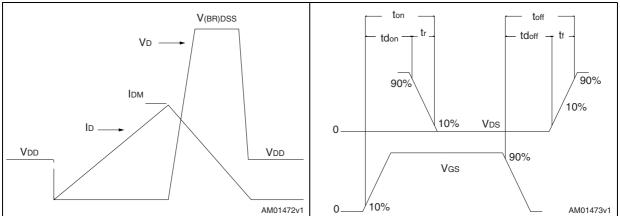


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



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# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.



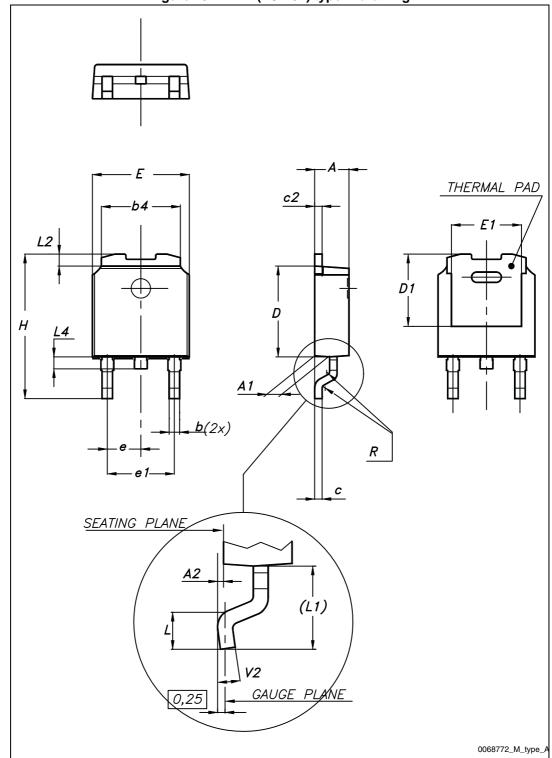


Figure 19. DPAK (TO-252) type A drawing



Table 9. DPAK (TO-252) type A mechanical data

D:	1000001217111(10	mm	
Dim.	Min.	Тур.	Max.
Α	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1		5.10	
E	6.40		6.60
E1		4.70	
е		2.28	
e1	4.40		4.60
Н	9.35		10.10
L	1.00		1.50
(L1)		2.80	
L2		0.80	
L4	0.60		1.00
R		0.20	
V2	0°		8°



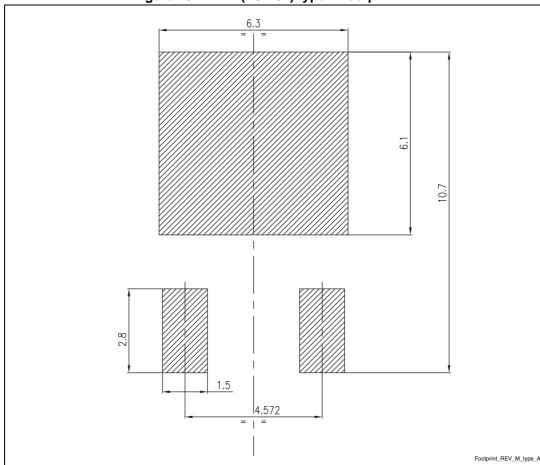


Figure 20. DPAK (TO-252) type A footprint <sup>(a)</sup>

a. All dimensions are in millimeters

# 5 Packaging mechanical data

Top cover tolerance on tape +/- 0.2 mm

Top cover tolerance on tape +/- 0.2 mm

For machine ref. only including draft and radii concentric around B0

User direction of feed

Bending radius

AM08852v1

Figure 21. Tape for DPAK (TO-252)

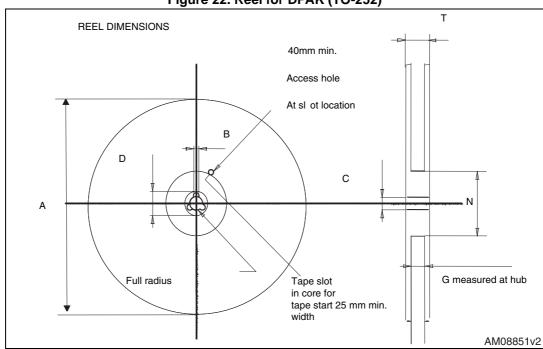


Figure 22. Reel for DPAK (TO-252)

Table 10. DPAK (TO-252) tape and reel mechanical data

Таре				Reel		
Dim.	n	nm	Dim.	mm		
Dilli.	Min.	Max.	Dilli.	Min.	Max.	
A0	6.8	7	Α		330	
В0	10.4	10.6	В	1.5		
B1		12.1	С	12.8	13.2	
D	1.5	1.6	D	20.2		
D1	1.5		G	16.4	18.4	
Е	1.65	1.85	N	50		
F	7.4	7.6	Т		22.4	
K0	2.55	2.75			•	
P0	3.9	4.1		Base qty.	2500	
P1	7.9	8.1		Bulk qty.	2500	
P2	1.9	2.1				
R	40					
Т	0.25	0.35				
W	15.7	16.3				

STD26P3LLH6 Revision history

# 6 Revision history

**Table 11. Document revision history** 

Date	Revision	Changes
22-Aug-2012	1	First release
31-Jan-2013	2	<ul> <li>Modified: R<sub>DS(on)</sub> on the title, Features table and Table 5</li> <li>Modified: typical values on Table 6, 7, 8</li> <li>Modified: V<sub>SD</sub> max value on Table 8</li> <li>Updated: Section 4: Package mechanical data</li> </ul>
16-Jul-2013	3	<ul> <li>Modified: V<sub>GS</sub> and I<sub>D</sub>=100 °C values in <i>Table 2</i></li> <li>Modified: R<sub>DS(on)</sub> max value in <i>Table 5</i>, <i>Figure 13</i>, <i>14</i> and <i>15</i></li> <li>Inserted: Section 2.1: Electrical characteristics (curves)</li> </ul>
10-Sep-2013	4	- Updated Q <sub>g</sub> value in <i>Table 6: Dynamic</i> .
06-Feb-2014	5	<ul> <li>Added: Table 4: Avalanche characteristics</li> <li>Modified: Figure 2, 5 and 12</li> <li>Updated: Section 4: Package mechanical data</li> <li>Added: Figure 16, 17 and 18</li> <li>Minor text changes</li> </ul>

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